| L Number | Hits | Search Text | DB | Time stamp |
|----------|------|-------------|-----|-----------|
| 1 | 1 | ultra near thin near semiconductor near package near device near method.ti. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2002/09/09 16:09 |
| 2 | 2 | JP-62147360-$.did. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2002/09/09 16:10 |
| 3 | 13605 | csp (chip near scale) (size near package) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2002/09/09 16:12 |
| 4 | 160 | (csp (chip near scale) (size near package)) and (tie near bar) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2002/09/09 16:13 |
| 5 | 134 | ((csp (chip near scale) (size near package)) and (tie near bar)) and @ad<20010305 | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2002/09/09 16:13 |